

Switchable Adhesives for Space Applications

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Research Overview

Research Question: Can we develop a switchable adhesive that works consistently and controllably in space?

Background:

- The International Space Station uses robotic arms for maintenance.
- Many connections and arrangements available → Versatile maintenance device.
- Switchable adhesives → consistent, controlled attachment mechanism
- Testing in pressure vacuum and ~ +/- 150°C

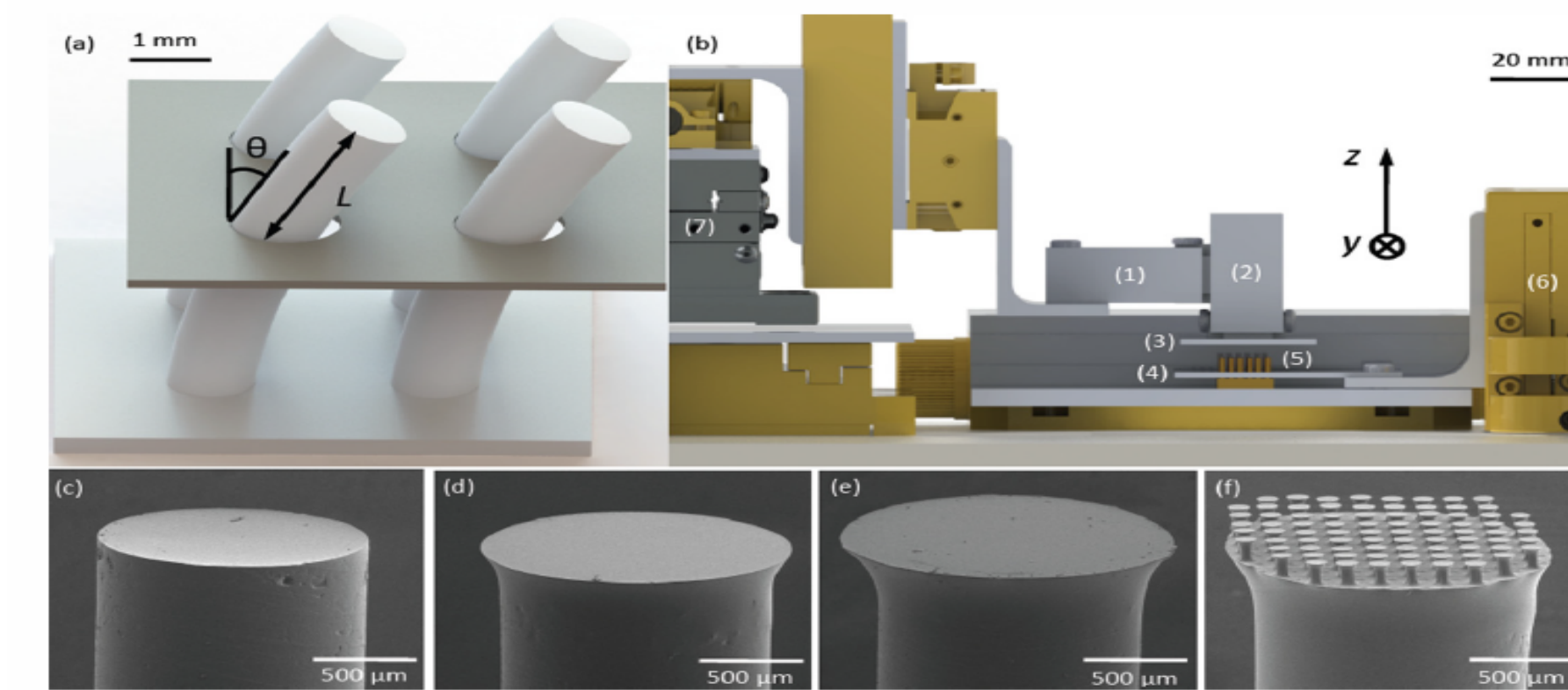


Figure 1: General trial for friction/adhesion characterization devices. [1]

Switchable Adhesives

Major inspiration:

- Gecko feet → hierarchical structure + biomechanics

Current Applications:

- Locomotion on smooth surfaces
- Pick and place

Current Switchable Mechanisms:

- Pre-compressive buckling
- Reduction of contact area
 - Mesh design [1]
 - Specified gripping/ releasing direction → triangles [2]
 - Magnetic field and cantilever beam control [3]

References:

- [1] Marvi, H., Y. Han, and M. Sitti. "Actively Controlled Fibrillar Friction Surfaces." *Appl. Phys. Lett. Applied Physics Letters* 106.5 (2015): 051602. Web.
[2] Jin, Kejia, et al. "Biomimetic bidirectional switchable adhesive inspired by the gecko." *Advanced Functional Materials* 24.5 (2014): 574-579.
[3] Northen, M. T., Greiner, C., Arzt, E. and Turner, K. L. (2008), A Gecko-Inspired Reversible Adhesive. *Adv. Mater.*, 20: 3905-3909.

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Experimental Setup

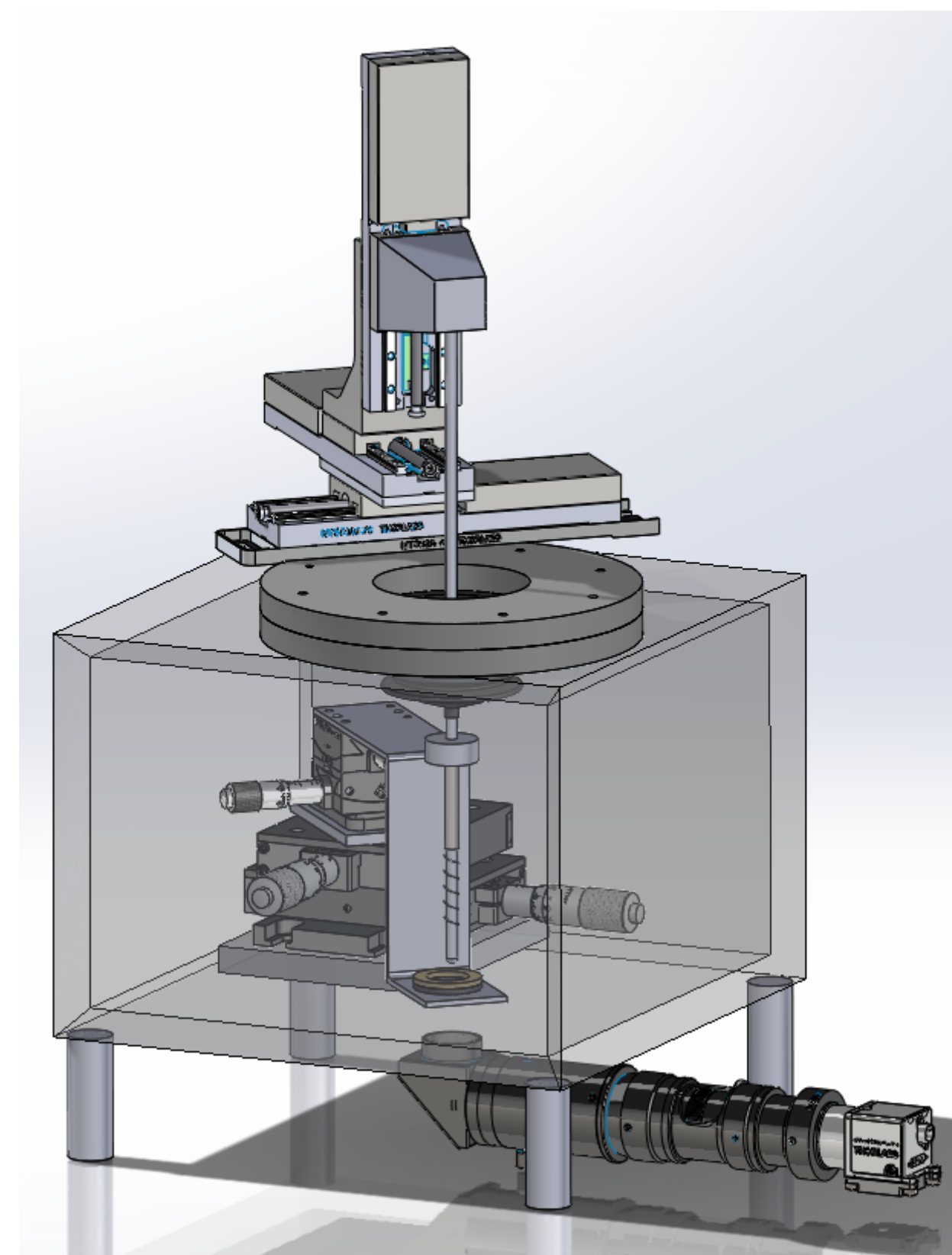
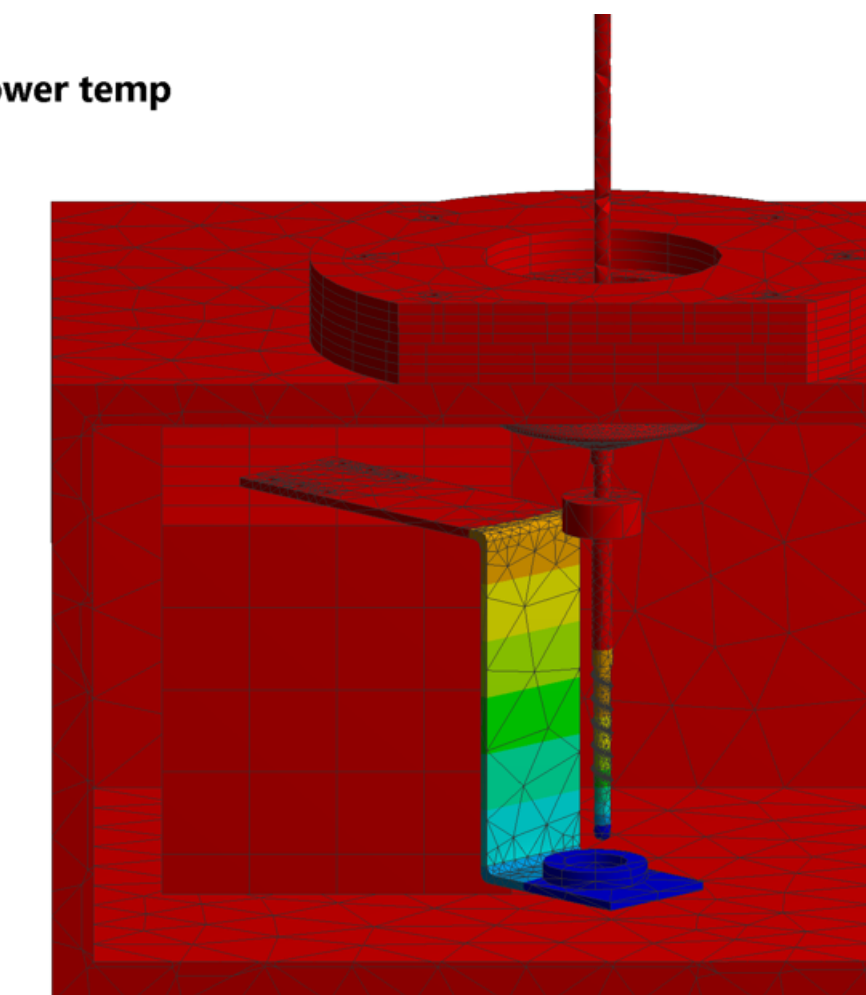
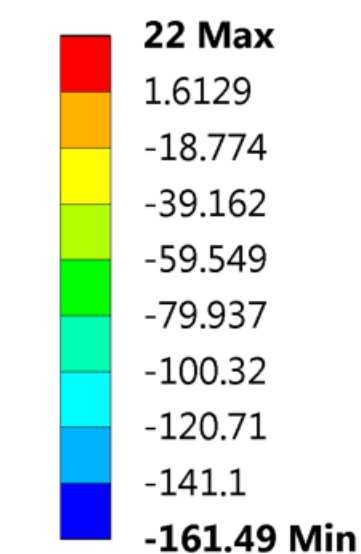


Figure 2: Solidworks model for the entire setup.

A: Transient Thermal lower temp

Temperature
Type: Temperature
Unit: °C
Time: 3600
3/31/2016 2:05 PM



B: Transient Thermal higher temp

Temperature
Type: Temperature
Unit: °C
Time: 3600
3/31/2016 2:08 PM

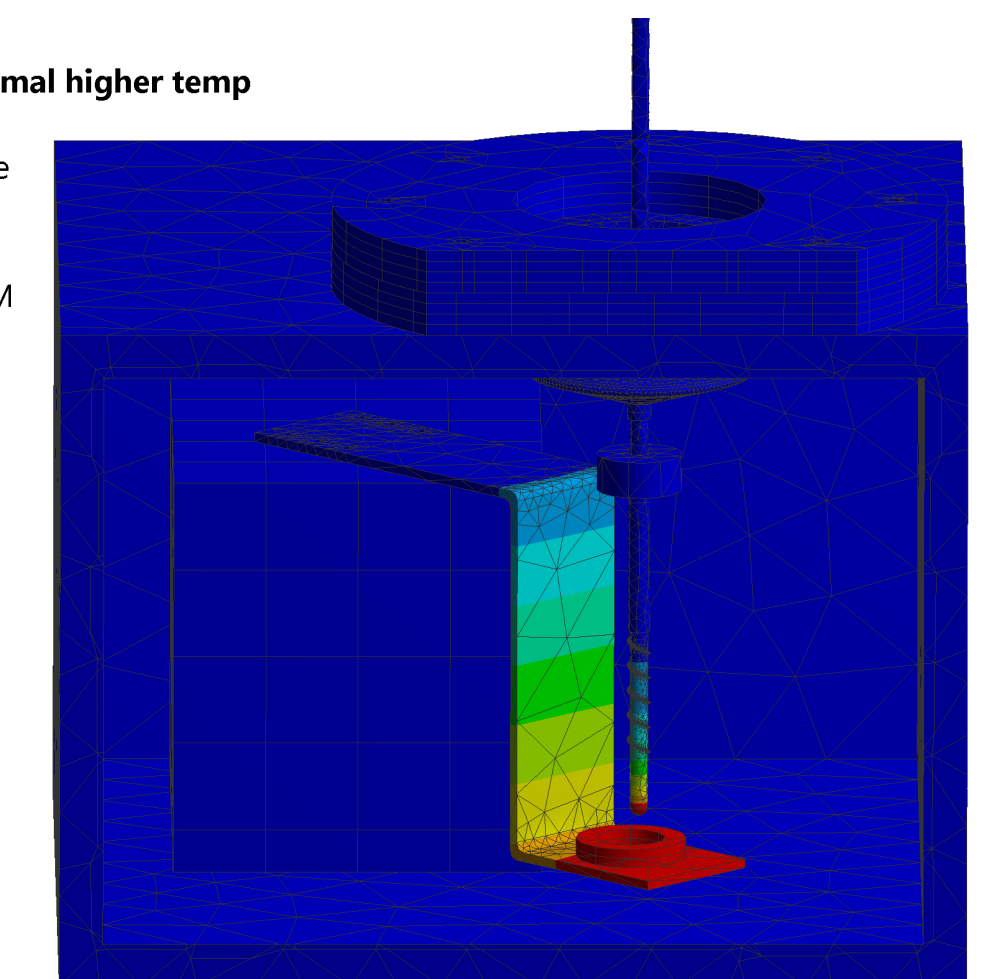
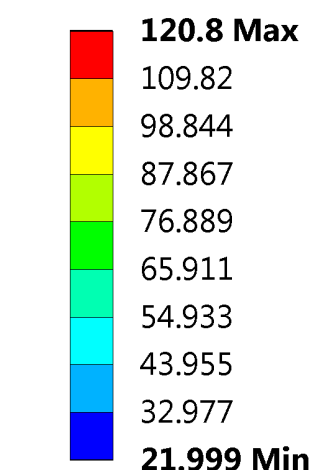


Figure 3: Thermal analysis of internal components at lower limit ~-160°C (left) and upper limit ~120°C for temperature.

Other Analysis and Considerations:

- Finite Element Analysis (FEA) for chamber under vacuum
- Temperature monitoring
- Heating and cooling stage
- Load cell in vacuum environment